VUSG006R25BNA

Datasheet

General Description

$V_{(BR)DSS}$	$R_{DS(ON)\_max}$	I_D
60V	2.5Ω@10V	0.34A
	3.0Ω@4.5V	

Symbol

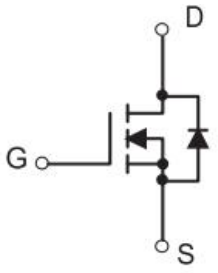
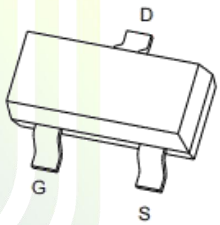


Figure 1 Symbol of VUSG006R25BNA

Features

- Trench Technology Power MOSFET
- Low R_{DSON}
- Low Gate Charge

Package Type



SOT-323

Figure 2 Package Type of VUSG006R25BNA

Application

- Power Switch Application
- Load Switch

Ordering Information

Product Name	Package
VUSG006R25BNA	SOT-323

Absolute Maximum Ratings (T_A= 25 ºC, unless otherwise specified)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	60	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current[Note1]	T_A= 25 ºC	I_D	0.34	A
Pulsed Drain Current [Note2]		I_{DM}	1.0	
Total Power Dissipation[Note4]	T_A= 25 ºC	P_D	0.3	W
Junction Temperature		T_J	150	ºC
Storage Temperature		T_{STG}	-55 to 150	ºC

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient [Note5]	$R_{\theta JA}$		416		ºC/W

Electrical Characteristics (T_J= 25 ºC, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D= 250uA	60			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}= 48V, V_{GS}=0V			1	uA
Gate-Body Leakage Current	I_{GSS}	V_{GS} = ±20V, V_{DS}= 0V			±95	nA
Gate Threshold Voltage[Note3]	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=250uA	1	1.5	2.5	V
Static Drain-Source On-Resistance[Note3]	$R_{DS(ON)}$	V_{GS}=10V, I_D= 0.3A		0.85	2.5	Ω
		V_{GS}=4.5V, I_D= 0.2A		0.95	3	
Dynamic Characteristics						
Input Capacitance	C_{ISS}	V_{DS}=30V		34.8		pF
Output Capacitance	C_{OSS}	V_{GS}=0V		6.4		pF
Reverse Transfer Capacitance	C_{RSS}	f=1MHz		3.5		pF
Total Gate Charge	Q_g	V_{DS}=30V		0.32		nC
Gate-Source Charge	Q_{gs}	V_{GS}=10V		0.25		
Gate-Drain Charge	Q_{gd}	I_D=0.3A		0.17		
Gate Resistance	Rg	f = 1MHz, Open drain		40		Ω
Switching Parameters						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}= 30V		3.8		ns
Turn-on Rise Time	t_r	V_{GS}= 10V		2.9		
Turn-off Delay Time	$t_{d(off)}$	R_L=100Ω		14		
Turn-off Fall Time	t_f	R_G=3Ω		8		
Diode Characteristics						
Diode Forward Voltage [Note3]	V_{SD}	V_{GS}=0V, I_S= 0.3A			1.2	V

Notes :

1.The maximum current rating is limited by package.And device mounted on a large heatsink.

2.Pulse Test : Pulse Width ≤ 10μs, duty cycle ≤ 1%.

3.Pulse Test : Pulse Width ≤ 300μs, duty cycle ≤ 2%.

4.The power dissipation P_D is limited by $T_{J(MAX)}$ = 150°C.And device mounted on a large heatsink

5.Device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

Typical Performance Characteristics

Figure 3: Transfer Characteristics

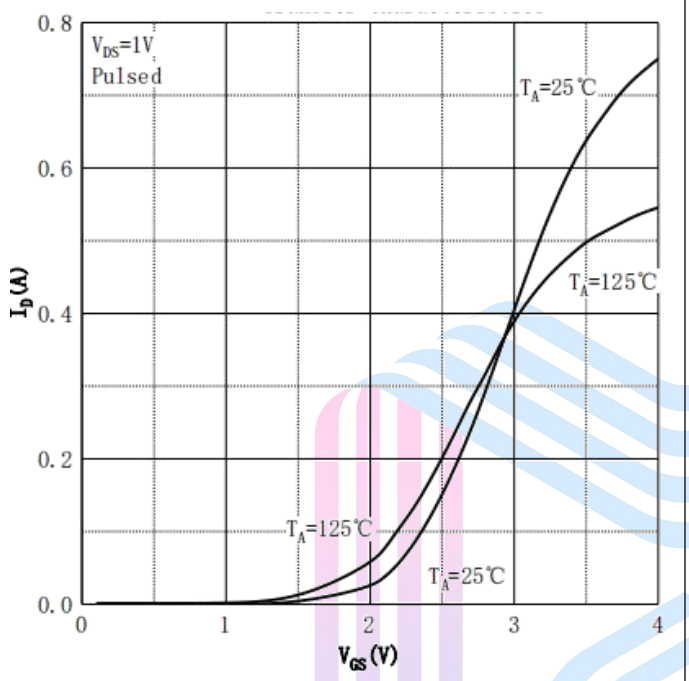


Figure 4: Output Characteristics

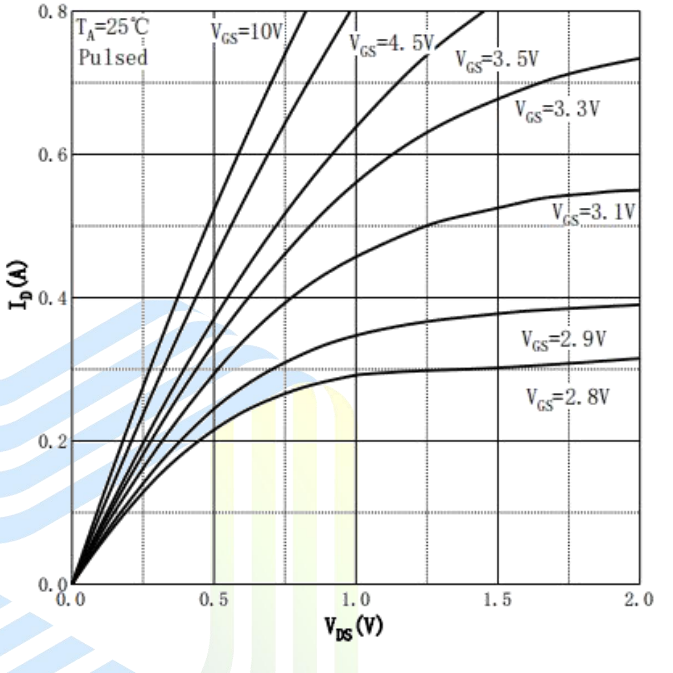


Figure 5: On-Resistance vs. Drain Current

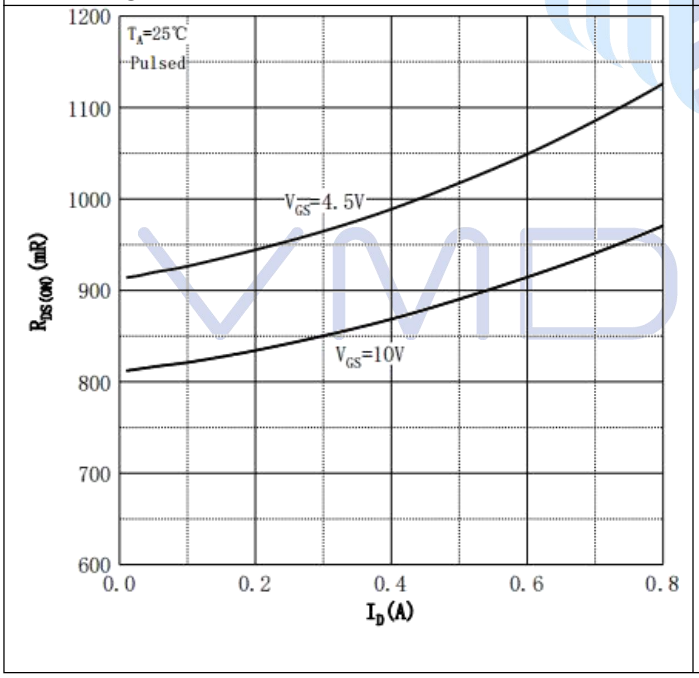


Figure 6: On-Resistance vs. Gate Voltage

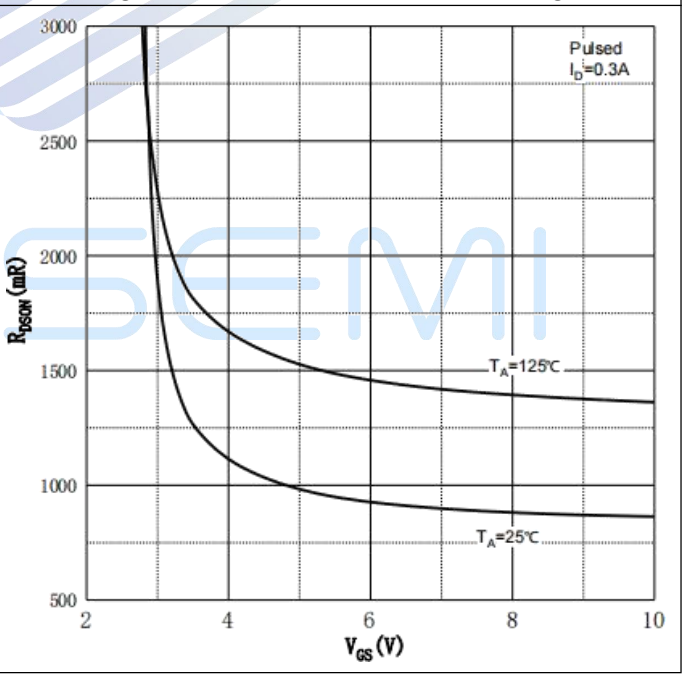


Figure 7: Body Diode Characteristics

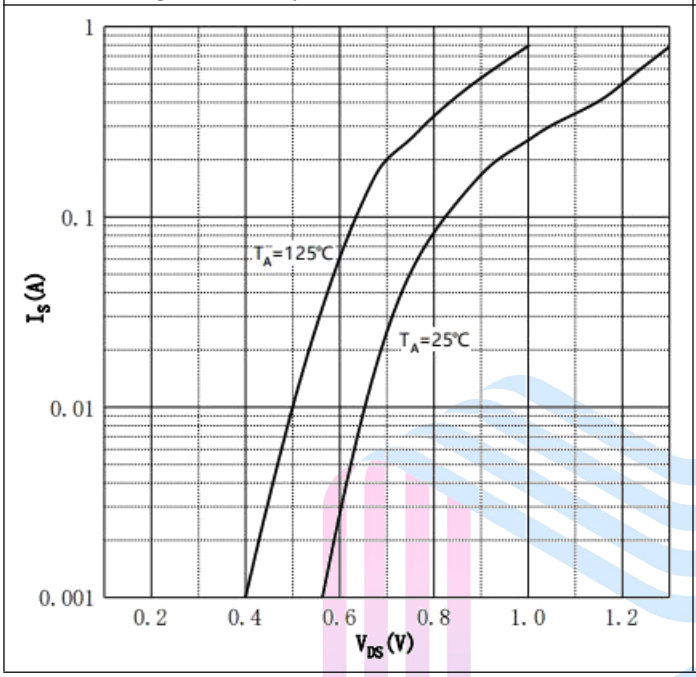
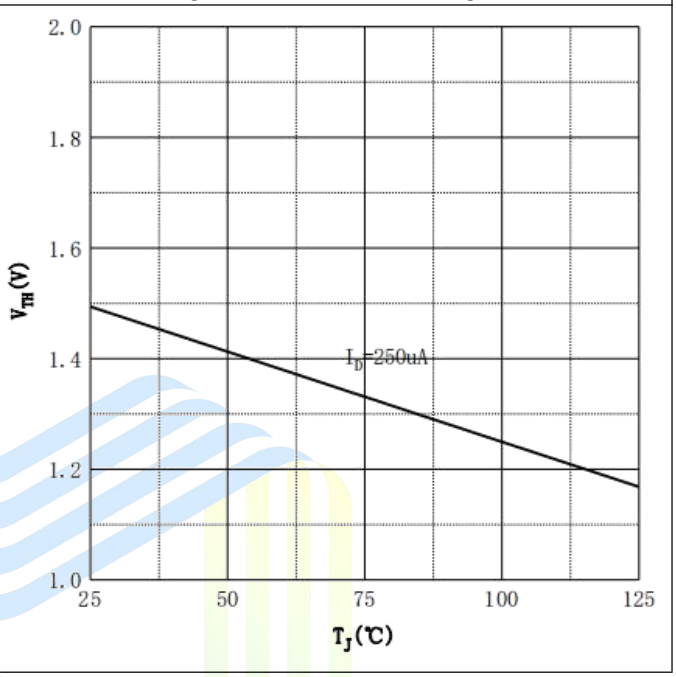
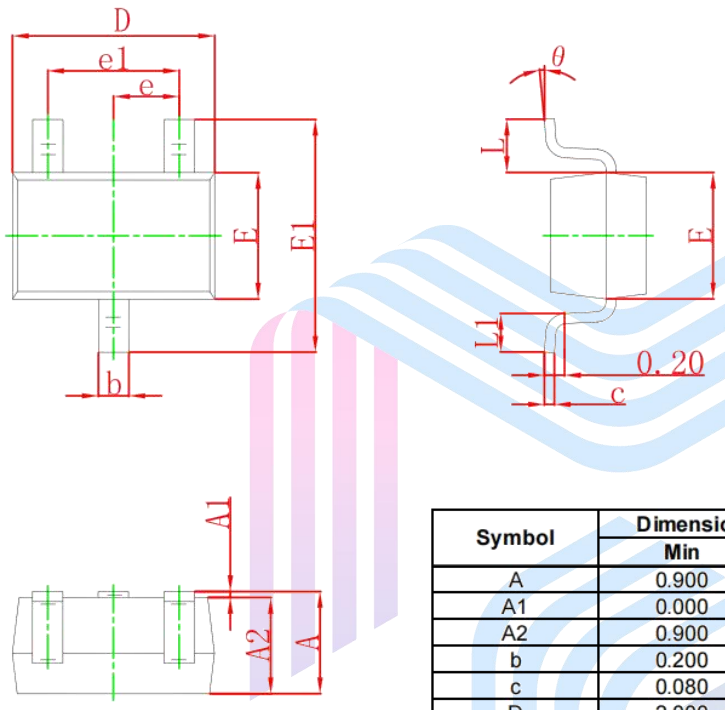


Figure 8: Threshold Voltage



Mechanical Dimensions:

SOT-323 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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